

CMOS Low Voltage 2.5 Ω Dual SPDT Switch

ADG736

FEATURES

1.8 V to 5.5 V single supply Automotive temperature range: -40°C to +125°C 2.5 Ω (typical) on resistance Low on resistance flatness -3 dB bandwidth > 200 MHz Rail-to-rail operation 10-lead MSOP package Fast switching times ton: 16 ns torF: 8 ns Typical power consumption (<0.01 μW) TTL-/CMOS-compatible

APPLICATIONS

USB 1.1 signal switching circuits Cell phones PDAs Battery-powered systems Communications systems Sample-and-hold systems Audio signal routing Audio and video switching Mechanical reed relay replacement

GENERAL DESCRIPTION

The ADG736 is a monolithic device comprising two independently selectable CMOS single pole, double throw (SPDT) switches. These switches are designed using a submicron process that provides low power dissipation yet gives high switching speed, low on resistance, low leakage currents, and wide input signal bandwidth.

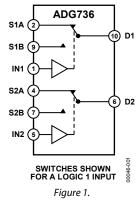
The on resistance profile is very flat over the full analog signal range. This ensures excellent linearity and low distortion when switching audio signals. Fast switching speed also makes the part suitable for video signal switching.

The ADG736 operates from a single 1.8 V to 5.5 V supply, making it ideally suited to portable and battery-powered instruments.

Each switch conducts equally well in both directions when on, and each has an input signal range that extends to the power supplies. The ADG736 exhibits break-before-make switching action.

The ADG736 is available in a 10-lead MSOP package.

FUNCTIONAL BLOCK DIAGRAM



PRODUCT HIGHLIGHTS

- 1.8 V to 5.5 V Single-Supply Operation. The ADG736 offers high performance, including low on resistance and fast switching times. It is fully specified and guaranteed with 3 V and 5 V supply rails.
- 2. Very Low R_{ON} (4.5 Ω Maximum at 5 V, 8 Ω Maximum at 3 V). At a supply voltage of 1.8 V, R_{ON} is typically 35 Ω over the temperature range.
- 3. Low On Resistance Flatness.
- 4. -3 dB Bandwidth > 200 MHz.
- 5. Low Power Dissipation. CMOS construction ensures low power dissipation.
- 6. Fast ton/toff.
- 7. Break-Before-Make Switching Action.
- 8. 10-Lead MSOP Package.

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Rev. C

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REVISION HISTORY

12/07—Rev. B to Rev. C

1/07—Rev. A to Rev. B	
Changes to Ordering Guide 1	2
Changes to Figure 4 and Figure 5	7
Changes to Features Section	1
Updated Temperature Range (Throughout)	1

Updated Format	Universal
Changes to Leakage Currents	
Changes to Leakage Currents	
Changes to Ordering Guide	
Updated Outline Dimensions	

11/03—Rev. 0 to Rev. A

Renumbered Figures and TPCs	Universal
Change to Title	
Changes to Applications	
Changes to Absolute Maximum Ratings	
Changes to Ordering Guide	
Changes to Test Circuit 3	7
Changes to Outline Dimensions	

SPECIFICATIONS

 V_{DD} = 5 V \pm 10%, GND = 0 V. All specifications –40°C to +125°C, unless otherwise noted.

Table 1.

	B Version				
	-40°C to -40°C		-40°C to		
Parameter	25°C	+85°C	+125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$0V$ to V_{DD}	V	
On Resistance (R _{ON})	2.5			Ωtyp	$V_s = 0 V$ to V_{DD} , $I_{DS} = -10 mA$; see Figure 10
	4	4.5	7	Ωmax	
On Resistance Match Between Channels (ΔR_{ON})	0.1			Ωtyp	$V_s = 0 V$ to V_{DD} , $I_{DS} = -10 \text{ mA}$
		0.4	0.4	Ωmax	
On Resistance Flatness (R _{FLAT (ON)})	0.5			Ωtyp	$V_s = 0 V$ to V_{DD} , $I_{DS} = -10 \text{ mA}$
		1.2	1.5	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 5.5 V$
Source Off Leakage I_S (Off)	±0.01		1	nA typ	$V_s = 4.5 V/1 V$, $V_D = 1 V/4.5 V$; see Figure 11
Channel On Leakage I _D , Is (On)	±0.01		5	nA typ	$V_s = V_D = 1 V \text{ or } 4.5 V$; see Figure 12
DIGITAL INPUTS					
Input High Voltage, V _{INH}		2.4	2.4	V min	
Input Low Voltage, V _{INL}		0.8	0.8	V max	
Input Current, IINL or IINH	0.005			μA typ	$V_{IN} = V_{INL} \text{ or } V_{INH}$
		± 0.1	± 0.1	μA max	
DYNAMIC CHARACTERISTICS ¹					
t _{on}	12			ns typ	$R_L=300~\Omega,~C_L=35~pF$
		16	16	ns max	V _s = 3 V; see Figure 13
toff	5			ns typ	$R_L=300~\Omega,~C_L=35~pF$
		8	8	ns max	V _s = 3 V; see Figure 13
Break-Before-Make Time Delay, t _D	7			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
		1	1	ns min	$V_{s1} = V_{s2} = 3 V$; see Figure 14
Off Isolation	-62			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$
	-82			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 15
Channel-to-Channel Crosstalk	-62			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$
	-82			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 16
Bandwidth (–3 dB)	200			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 17
C _s (Off)	9			pF typ	
C _D , C _s (On)	32			pF typ	
POWER REQUIREMENTS					$V_{DD} = 5.5 V$
I _{DD}	0.001			μA typ	Digital inputs = 0 V or 5 V
		1.0	1.0	µA max	

¹ Guaranteed by design; not subject to production test.

 V_{DD} = 3 V \pm 10%, GND = 0 V. All specifications –40°C to +125°C, unless otherwise noted.

Table 2.

	B Version				
Parameter	25°C	-40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$0 V to V_{\text{DD}}$	V	
On Resistance (R _{ON})	5	5.5		Ω typ	$V_s = 0 V$ to V_{DD} , $I_{Ds} = -10 mA$; see Figure 10
		8	12	Ωmax	See Figure 10
On Resistance Match Between Channels (ΔR_{ON})	0.1			Ωtyp	$V_s = 0 V$ to V_{DD} , $I_{Ds} = -10 \text{ mA}$
		0.4	0.4	Ωmax	
On Resistance Flatness (R _{FLAT (ON)})		2.5	2.5	Ωtyp	$V_s = 0 V$ to V_{DD} , $I_{Ds} = -10 \text{ mA}$
LEAKAGE CURRENTS					$V_{DD} = 3.3 V$
Source Off Leakage Is (Off)	±0.01		1	nA typ	$V_{s} = 3 V/1 V$, $V_{D} = 1 V/3 V$; see Figure 11
Channel On Leakage I _D , I _s (On)	±0.01		5	nA typ	$V_s = V_D = 1 V \text{ or } 3 V$; see Figure 12
DIGITAL INPUTS					
Input High Voltage, VINH		2.0	2.4	V min	
Input Low Voltage, V _{INL}		0.4	0.8	V max	
Input Current, I _{INL} or I _{INH}	0.005			μA typ	$V_{IN} = V_{INL} \text{ or } V_{INH}$
		±0.1	± 0.1	μA max	
DYNAMIC CHARACTERISTICS ¹					
ton	14			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
		20	20	ns max	$V_s = 2 V$; see Figure 13
toff	6			ns typ	$R_L = 300 \Omega$, $C_L = 35 pF$
		10	10	ns max	V _s = 2 V; see Figure 13
Break-Before-Make Time Delay, t _D	7			ns typ	$R_L=300~\Omega,~C_L=35~pF$
		1	1	ns min	$V_{S1} = V_{S2} = 2 V$; see Figure 14
Off Isolation	-62			dB typ	$R_L = 50 \ \Omega$, $C_L = 5 \ pF$, $f = 10 \ MHz$
	-82			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 15
Channel-to-Channel Crosstalk	-62			dB typ	$R_L = 50 \ \Omega$, $C_L = 5 \ pF$, $f = 10 \ MHz$
	-82			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 16
Bandwidth (–3 dB)	200			MHz typ	$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 17
C _s (Off)	9			pF typ	
C _D , C _s (On)	32			pF typ	
POWER REQUIREMENTS					$V_{DD} = 3.3 V$
lod	0.001			μA typ	Digital inputs = 0 V or 3 V
		1.0	1.0	μA max	

¹ Guaranteed by design; not subject to production test.

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 3.

Tuble 51	
Parameter	Rating
V _{DD} to GND	–0.3 V to +6 V
Analog, Digital Inputs ¹	-0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Continuous Current, S or D	30 mA
Peak Current, S or D	100 mA (Pulsed at 1 ms, 10% duty cycle maximum)
Operating Temperature Range	
Automotive	-40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
MSOP Package, Power Dissipation	315 mW
θ_{JA} Thermal Impedance	205°C/W
Lead Temperature (Soldering, 10 sec)	300°C
IR Reflow (Peak Temperature, <20 sec)	235°C
Lead-Free Reflow Soldering	
Peak Temperature	260(+0/-5)°C
Time at Peak Temperature	10 sec to 40 sec
ESD	2 kV

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

¹ Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

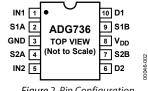


Figure 2. Pin Configuration

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	IN1	Logic Control Input.
2	S1A	Source Terminal. May be an input or output.
3	GND	Ground (0 V) Reference.
4	S2A	Source Terminal. May be an input or output.
5	IN2	Logic Control Input.
б	D2	Drain Terminal. May be an input or output.
7	S2B	Source Terminal. May be an input or output.
8	V _{DD}	Most Positive Power Supply Potential.
9	S1B	Source Terminal. May be an input or output.
10	D1	Drain Terminal. May be an input or output.

Table 5. Truth Table

Logic	Switch A	Switch B
0	Off	On
_1	On	Off

TYPICAL PERFORMANCE CHARACTERISTICS

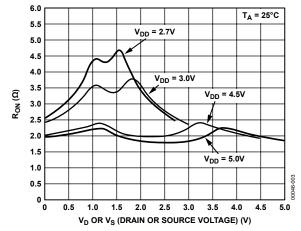


Figure 3. On Resistance as a Function of V_D or V_S Single Supplies

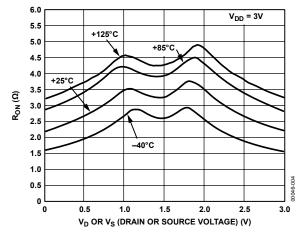


Figure 4. On Resistance as a Function of $V_{\rm D}$ or $V_{\rm S}$ for Different Temperatures $V_{\rm DD}$ = 3 V

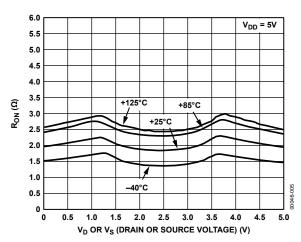


Figure 5. On Resistance as a Function of $V_{\rm D}$ or $V_{\rm S}$ for Different Temperatures $V_{\rm DD}$ = 5 V

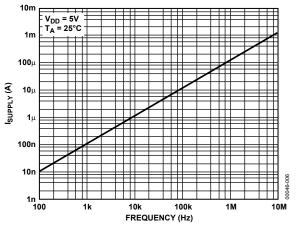
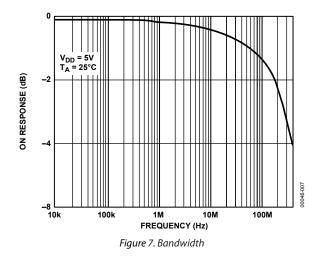


Figure 6. Supply Current vs. Input Switching Frequency



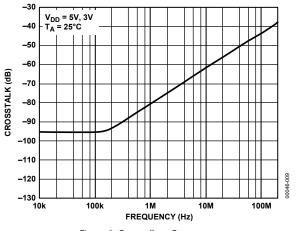
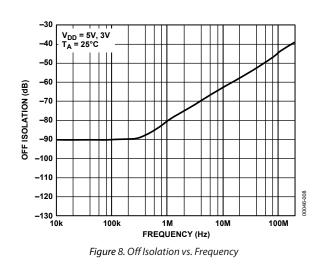


Figure 9. Crosstalk vs. Frequency



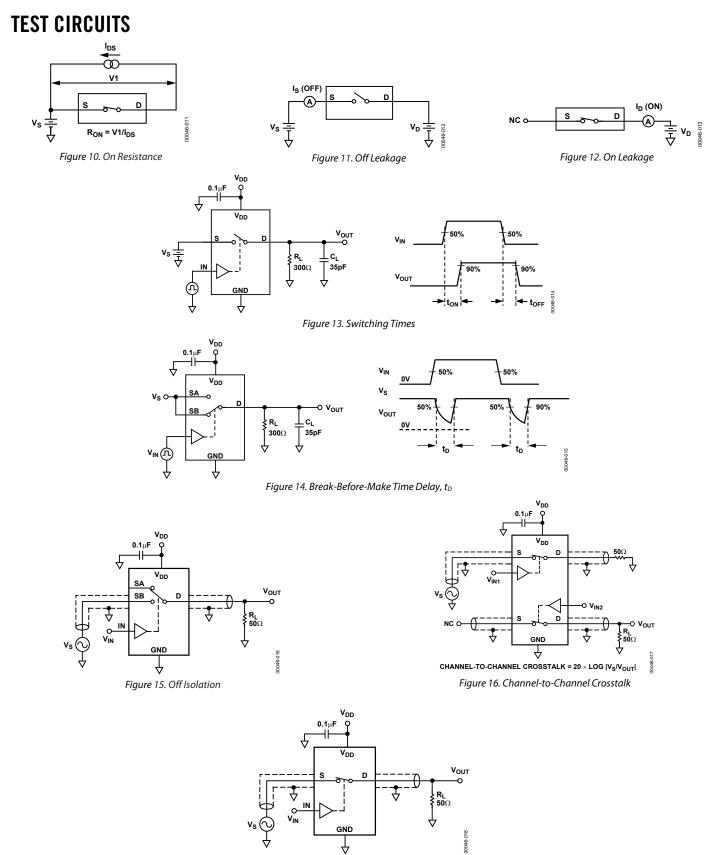


Figure 17. Bandwidth

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TERMINOLOGY

Ron

Ohmic resistance between Terminal D and Terminal S.

ΔR_{ON}

On resistance match between any two channels; that is, $R_{\rm ON}$ maximum – $R_{\rm ON}$ minimum.

$R_{\rm FLAT \ (ON)}$

Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.

Is (Off) Source leakage current with the switch off.

 I_D , I_S (On) Channel leakage current with the switch on.

 $\mathbf{V}_{\mathrm{D}}\left(\mathbf{V}_{S}\right)$ Analog voltage on Terminal D and Terminal S.

Cs (Off) Off switch source capacitance.

С_D, **С**_S (**On**) On switch capacitance.

ton

Delay between applying the digital control input and the output switching on. See Figure 13.

toff

Delay between applying the digital control input and the output switching off. See Figure 13.

t_D

Off time or on time measured between the 90% points of both switches, when switching from one address state to another. See Figure 14.

Crosstalk

A measure of unwanted signal that is coupled from one channel to another as a result of parasitic capacitance.

Off Isolation

A measure of unwanted signal coupling through an off switch.

Bandwidth

The frequency at which the output is attenuated by -3 dB.

On Response

The frequency response of the on switch.

On Loss

The voltage drop across the on switch, seen on the on response vs. frequency plot (see Figure 7) as how many decibels (dB) the signal is away from 0 dB at very low frequencies.

APPLICATIONS INFORMATION

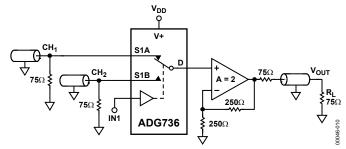
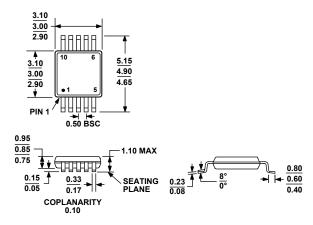


Figure 18. Using the ADG736 to Select Between Two Video Signals

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 19. 10-Lead Mini Small Outline Package [MSOP] (RM-10) Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
ADG736BRM	-40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB
ADG736BRM-REEL	-40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB
ADG736BRM-REEL7	-40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB
ADG736BRMZ ¹	-40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB#
ADG736BRMZ-REEL ¹	-40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB#
ADG736BRMZ-REEL71	–40°C to +125°C	10-Lead Mini Small Outline Package (MSOP)	RM-10	SAB#

¹ Z = RoHS Compliant Part, # denotes RoHS compliant part may be top or bottom marked.

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